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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

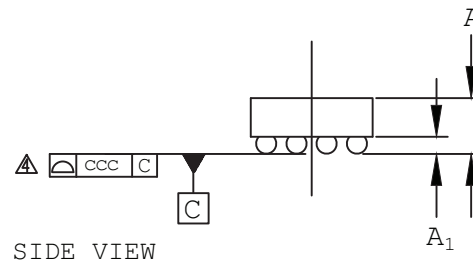
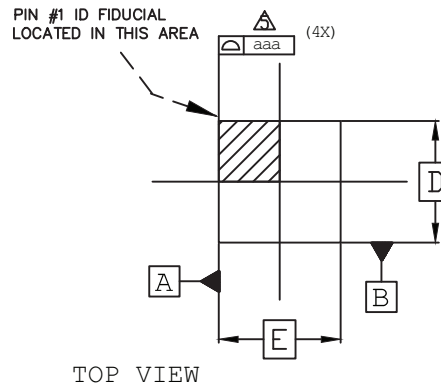
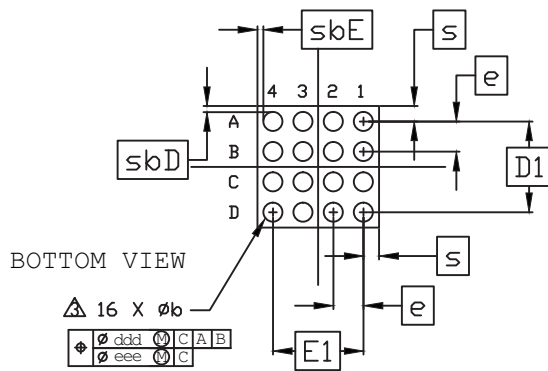
The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |                                                                                                                                                                   |
|--------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product Status                 | Obsolete                                                                                                                                                          |
| Number of LABs/CLBs            | -                                                                                                                                                                 |
| Number of Logic Elements/Cells | 32800                                                                                                                                                             |
| Total RAM Bits                 | 434176                                                                                                                                                            |
| Number of I/O                  | 360                                                                                                                                                               |
| Number of Gates                | -                                                                                                                                                                 |
| Voltage - Supply               | 1.14V ~ 1.26V                                                                                                                                                     |
| Mounting Type                  | Surface Mount                                                                                                                                                     |
| Operating Temperature          | -40°C ~ 100°C (TJ)                                                                                                                                                |
| Package / Case                 | 484-BBGA                                                                                                                                                          |
| Supplier Device Package        | 484-FPBGA (23x23)                                                                                                                                                 |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec33e-4f484i">https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec33e-4f484i</a> |

## 16-Ball WLCS Package Option 2: iCE40 UltraLite™

Dimensions in Millimeters



### NOTES:

1. ALL DIMENSIONS AND TOLERANCE PER ASME Y 14.5M - 1994.

2. ALL DIMENSIONS ARE IN MILLIMETERS.

$\Delta$  DIMENSION "b" IS MEASURES AT THE MAXIMUM BUMP DIAMETER PARALLEL TO PRIMARY DATUM C.

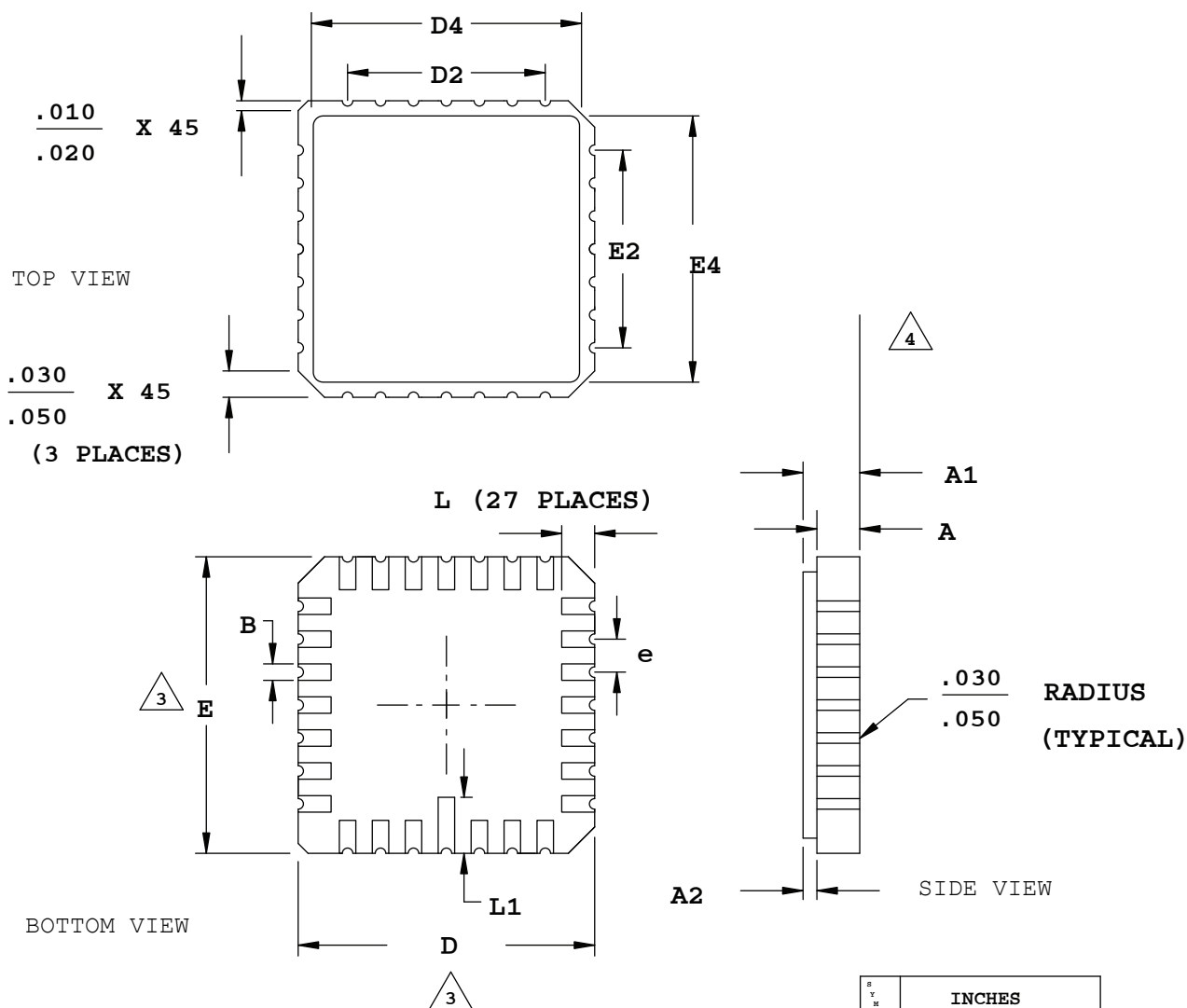
$\Delta$  PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BUMPS.

$\Delta$  BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

| REF. | Min.      | Nom.  | Max.  |
|------|-----------|-------|-------|
| A    | 0.413     | 0.452 | 0.491 |
| A1   | 0.122     | 0.152 | 0.182 |
| b    | 0.188     | 0.218 | 0.248 |
| D    | 1.409 BSC |       |       |
| E    | 1.409 BSC |       |       |
| D1   | 1.05 BSC  |       |       |
| E1   | 1.05 BSC  |       |       |
| e    | 0.35 BSC  |       |       |
| s    | -         | 0.180 | -     |
| skD  | 0.067     | 0.071 | 0.072 |
| skE  | 0.067     | 0.071 | 0.072 |
| aaa  | 0.03      |       |       |
| ccc  | 0.03      |       |       |
| ddd  | 0.050     |       |       |
| eee  | 0.015     |       |       |

## 28-Pin LCC Package

Dimensions in Inches



### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5.

2. ALL DIMENSIONS ARE IN INCHES.

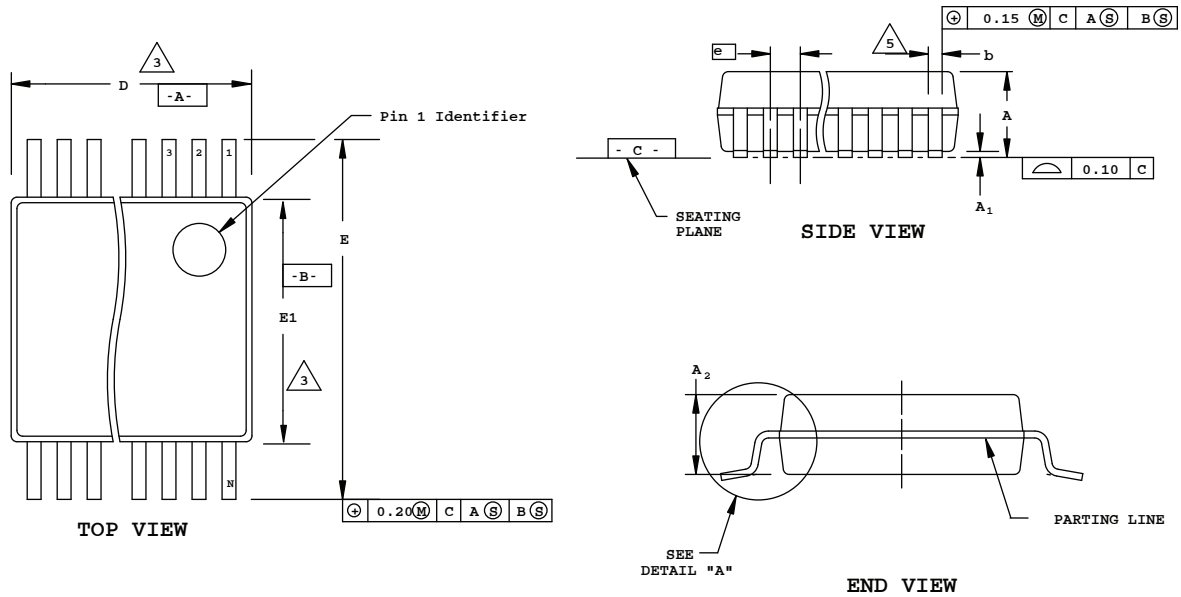
3. DIMENSIONS D AND E MAY HAVE MATERIAL PROTRUSION OF .010 INCHES MAXIMUM ABOVE THE DIMENSION SHOWN NOT TO EXCEED .005 INCHES MAXIMUM PER SIDE.

4. FLATNESS TOLERANCE IS .004 INCHES PER INCH.

| SYMBOL | INCHES   |  |      |
|--------|----------|--|------|
|        | MIN.     |  | MAX. |
| A      | .054     |  | .074 |
| A1     | .064     |  | .089 |
| A2     | .007     |  | .015 |
| B      | .022     |  | .028 |
| D      | .440     |  | .460 |
| D2     | .300     |  |      |
| D4     | .370     |  | .403 |
| E      | .440     |  | .460 |
| E2     | .300     |  |      |
| E4     | .370     |  | .403 |
| e      | .050 BSC |  |      |
| L      | .042     |  | .058 |
| L1     | .075     |  | .095 |

## 28-Pin SSOP Package

Dimensions in Millimeters



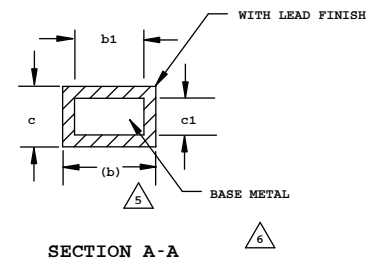
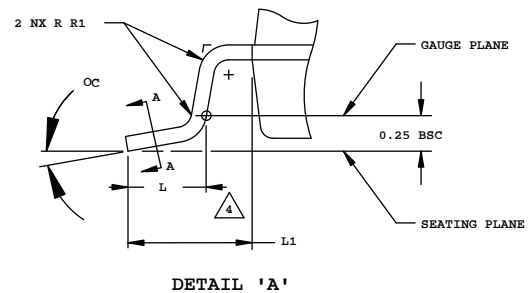
| SYMBOL         | COMMON DIMENSIONS |       |       |
|----------------|-------------------|-------|-------|
|                | MIN.              | NOM.  | MAX.  |
| A              | --                | --    | 2.0   |
| A <sub>1</sub> | 0.05              | --    | --    |
| A <sub>2</sub> | 1.65              | 1.75  | 1.85  |
| b              | 0.22              | --    | 0.38  |
| b <sub>1</sub> | 0.22              | 0.30  | 0.33  |
| c              | 0.09              | --    | 0.25  |
| c <sub>1</sub> | 0.09              | 0.15  | 0.21  |
| D              | 9.90              | 10.20 | 10.50 |
| E1             | 5.00              | 5.30  | 5.60  |
| e              | 0.65 BSC          |       |       |
| E              | 7.40              | 7.80  | 8.20  |
| L              | 0.55              | 0.75  | 0.95  |
| L1             | 1.25 REF.         |       |       |
| N              | 28                |       |       |
| OC             | 0                 | 4     | 8     |
| R1             | 0.09              | --    | --    |

### NOTES:

1. CONTROLLING DIMENSION: MILLIMETERS.
2. DIMENSIONING & TOLERANCES PER ANSI.Y14.5M-1982.

3. "D" & "E1" DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS, BUT DO INCLUDE MOLD MISMATCH AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.20mm PER SIDE.

4. TO BE DETERMINED AT THE SEATING PLANE



5. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13mm TOTAL IN EXCESS OF b DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION b BY MORE THAN 0.07mm AT LEAST MATERIAL CONDITION.

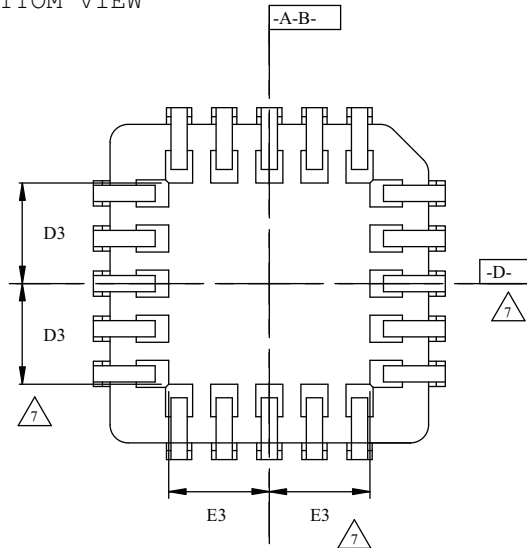
6. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 & 0.25mm FROM THE LEAD TIP

7. "N" IS THE NUMBER OF TERMINAL POSITIONS

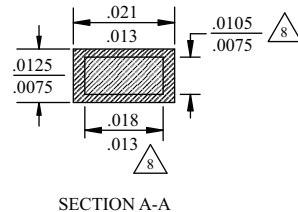
## 44-Pin PLCC Package

Dimensions in Inches

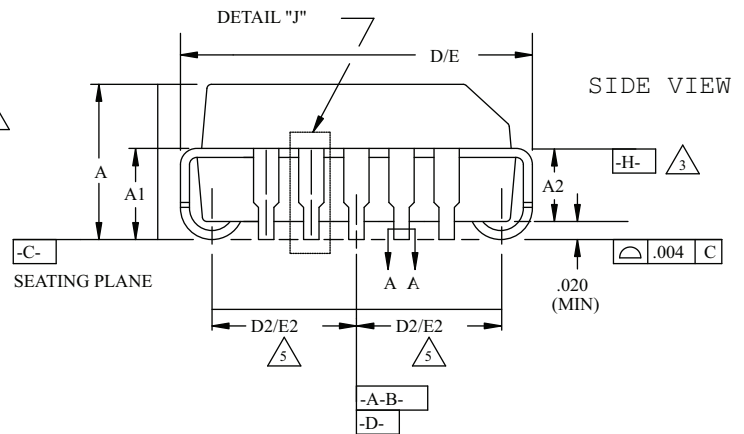
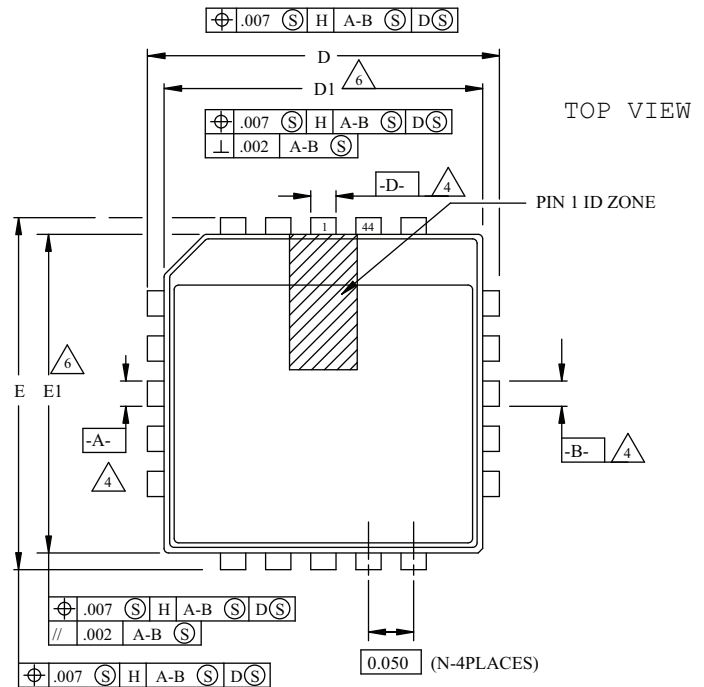
BOTTOM VIEW



|    | MIN. | NOM. | MAX. |
|----|------|------|------|
| A  | .165 | .172 | .180 |
| A1 | .090 | .105 | .120 |
| A2 | .062 | -    | .083 |
| D  | .685 | .690 | .695 |
| D1 | .650 | .653 | .656 |
| D2 | .291 | .305 | .319 |
| D3 |      | .225 |      |
| E  | .685 | .690 | .695 |
| E1 | .650 | .653 | .656 |
| E2 | .291 | .305 | .319 |
| E3 |      | .225 |      |
| N  |      | 44   |      |

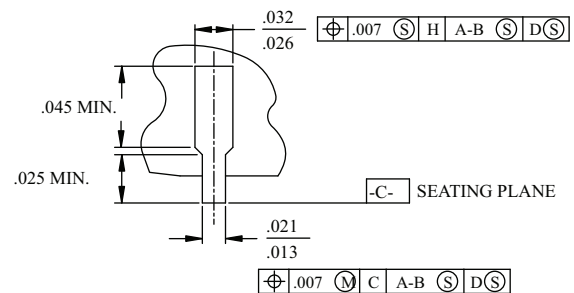


SECTION A-A



### NOTES:

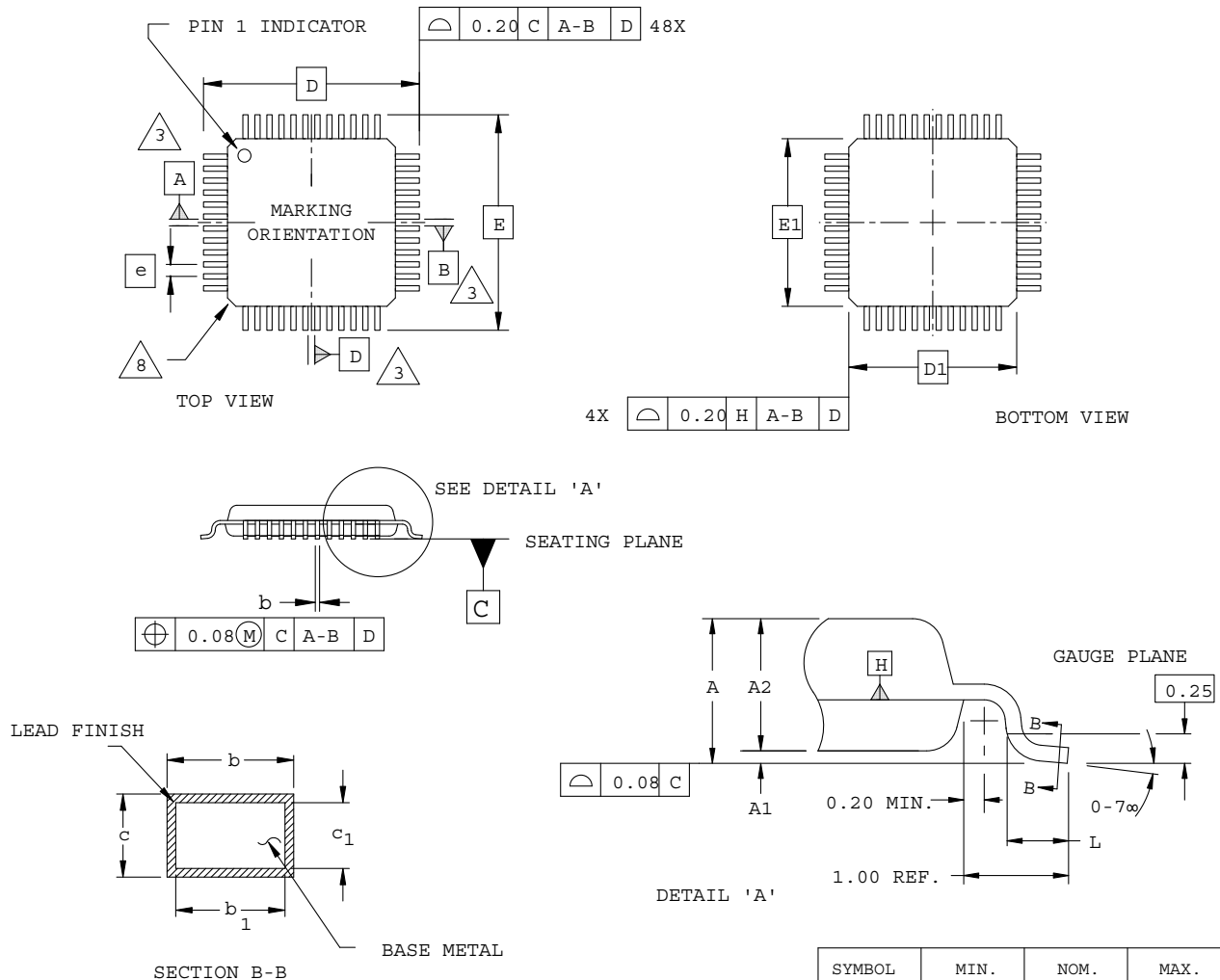
- ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1982
- ALL DIMENSIONS IN INCHES
- DATUM PLANE  $\square$  H- LOCATED AT TOP OF MOLD PARTING LINE AND COINCIDENT WITH TOP OF LEAD WHERE LEAD EXITS PLASTIC BODY
- DATUMS  $\square$  A-B AND  $\square$  D- TO BE DETERMINED WHERE CENTER LEADS EXIT PLASTIC BODY AT DATUM PLANE  $\square$  H-
- TO BE MEASURED AT SEATING PLANE  $\square$  C- CONTACT POINT
- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS .010 PER SIDE.
- TOP POINT OF MEASUREMENT IS DATUM  $\square$  H- ; BOTTOM POINT OF MEASUREMENT IS AT MAJOR FLAT AREA OF LOWER PLASTIC SURFACE DEFINED BY D3/E3
- DIMENSION APPLIES TO BASE METAL ONLY



DETAIL "J" (TYP ALL SIDES)

## 48-Pin TQFP Package (1.0 mm thick)

Dimensions in Millimeters

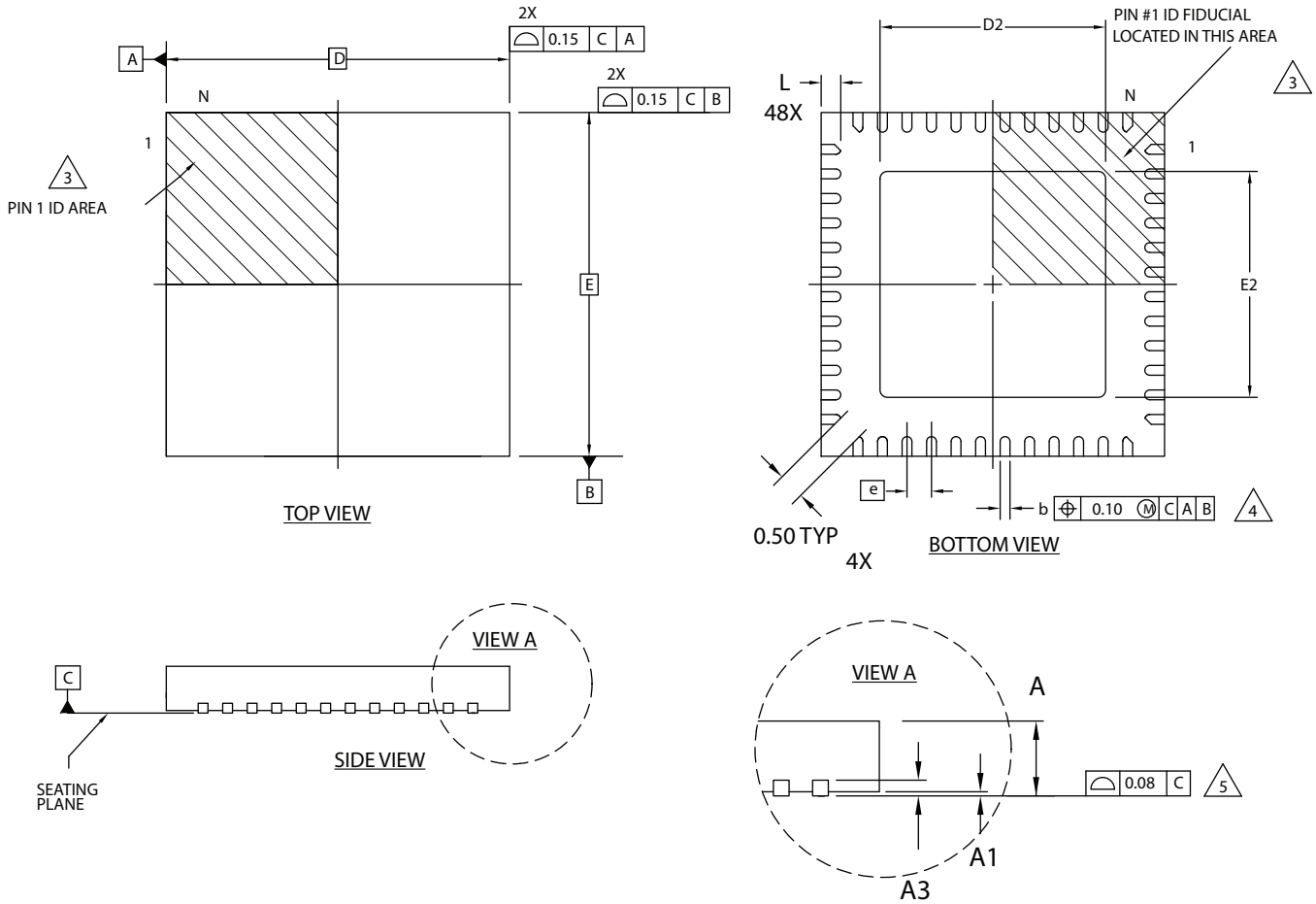


### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5 - 1982.
- ALL DIMENSIONS ARE IN MILLIMETERS.
- DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON D1 AND E1 DIMENSIONS.
- THE TOP OF PACKAGE MAY BE SMALLER THAN THE BOTTOM OF THE PACKAGE BY 0.15 MM.
- SECTION B-B:  
THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP.
- A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.
- EXACT SHAPE OF EACH CORNER IS OPTIONAL.

## 48-Pin QFN Package Option 1

Dimensions in Millimeters



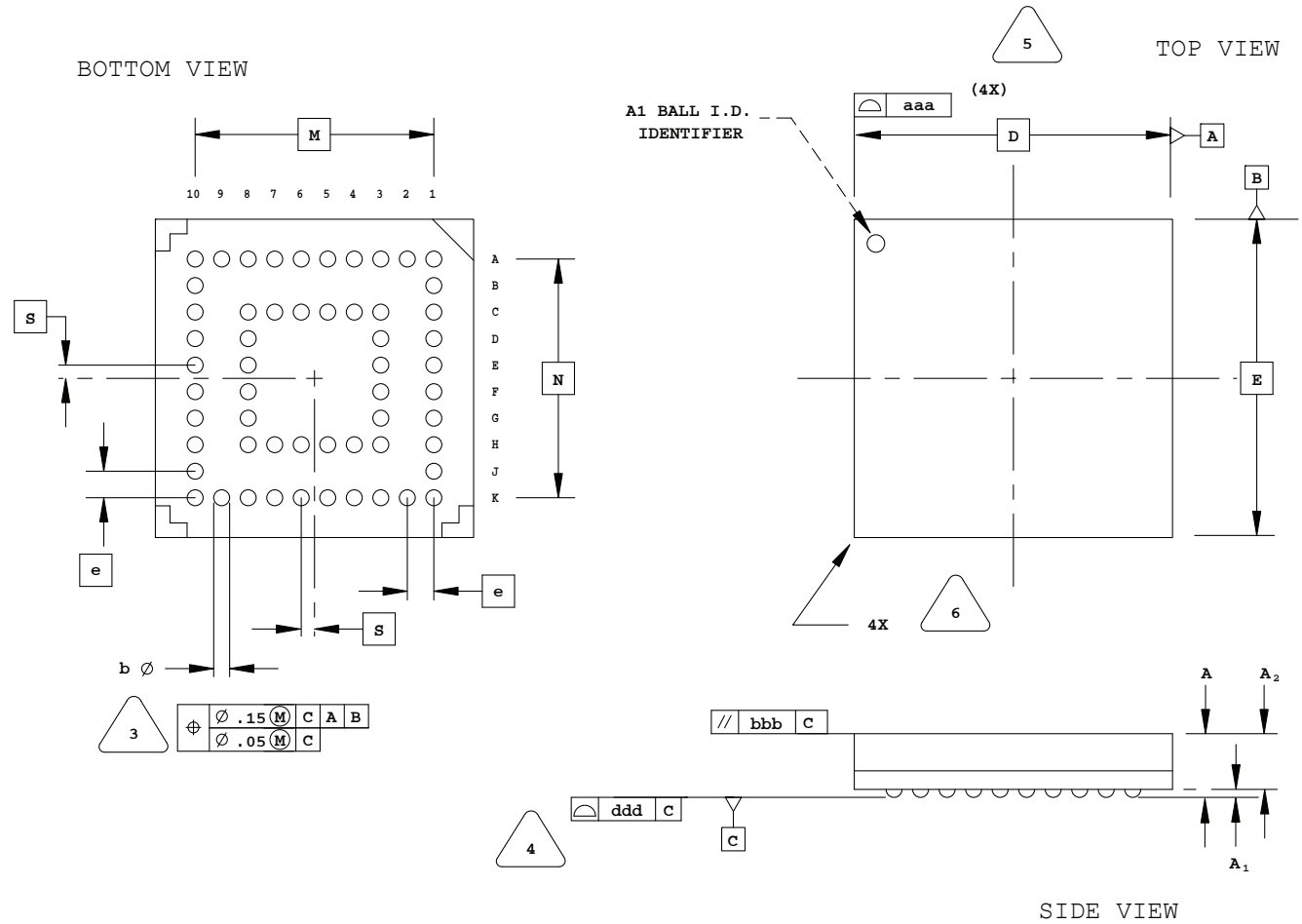
NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
2. ALL DIMENSIONS ARE IN MILLIMETERS.
3. EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.
4. DIMENSION  $b$  APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL TIP.
5. APPLIES TO EXPOSED PORTION OF TERMINALS.

| SYMBOL | MIN.     | NOM. | MAX. |
|--------|----------|------|------|
| A      | 0.80     | 0.90 | 1.00 |
| A1     | 0.00     | 0.02 | 0.05 |
| A3     | 0.2 REF  |      |      |
| D      | 7.0 BSC  |      |      |
| D2     | 3.00     | -    | 5.80 |
| E      | 7.0 BSC  |      |      |
| E2     | 3.00     | -    | 5.80 |
| b      | 0.18     | 0.24 | 0.30 |
| e      | 0.50 BSC |      |      |
| L      | 0.30     | 0.40 | 0.50 |

## 56-Ball csBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

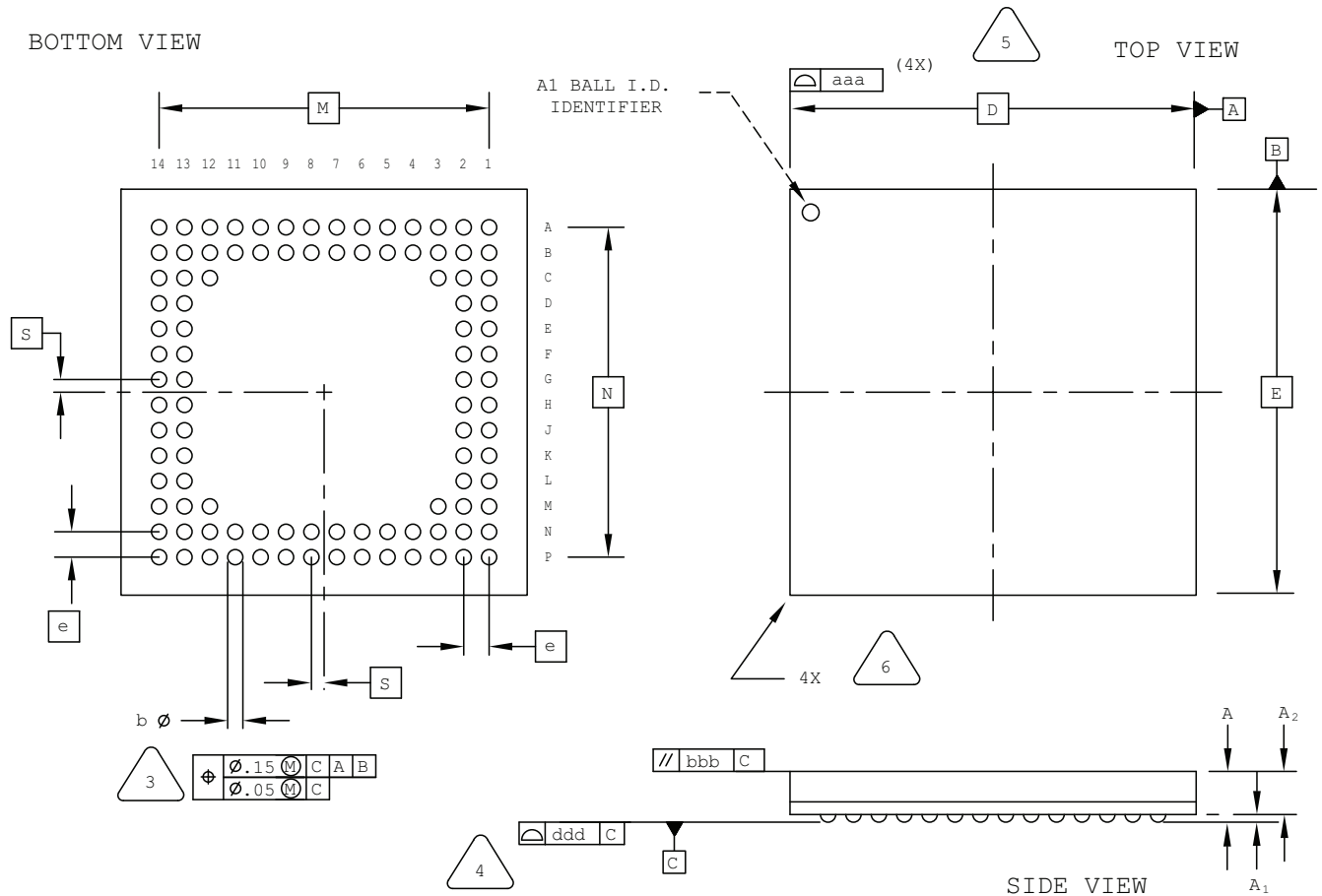
1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
2. ALL DIMENSIONS ARE IN MILLIMETERS.

3. DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C
4. PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
5. BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.
6. EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

| SYMBOL | MIN.     | NOM. | MAX. |
|--------|----------|------|------|
| A      | 1.10     | 1.23 | 1.35 |
| A1     | 0.15     | -    | -    |
| A2     | -        | -    | 1.10 |
| D/E    | 6.00 BSC |      |      |
| M/N    | 4.50 BSC |      |      |
| S      | 0.25 BSC |      |      |
| b      | 0.25     | 0.30 | 0.35 |
| e      | 0.50 BSC |      |      |
| aaa    | -        | -    | 0.10 |
| bbb    | -        | -    | 0.10 |
| ddd    | -        | -    | 0.08 |

## 100-Ball csBGA Package

### Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

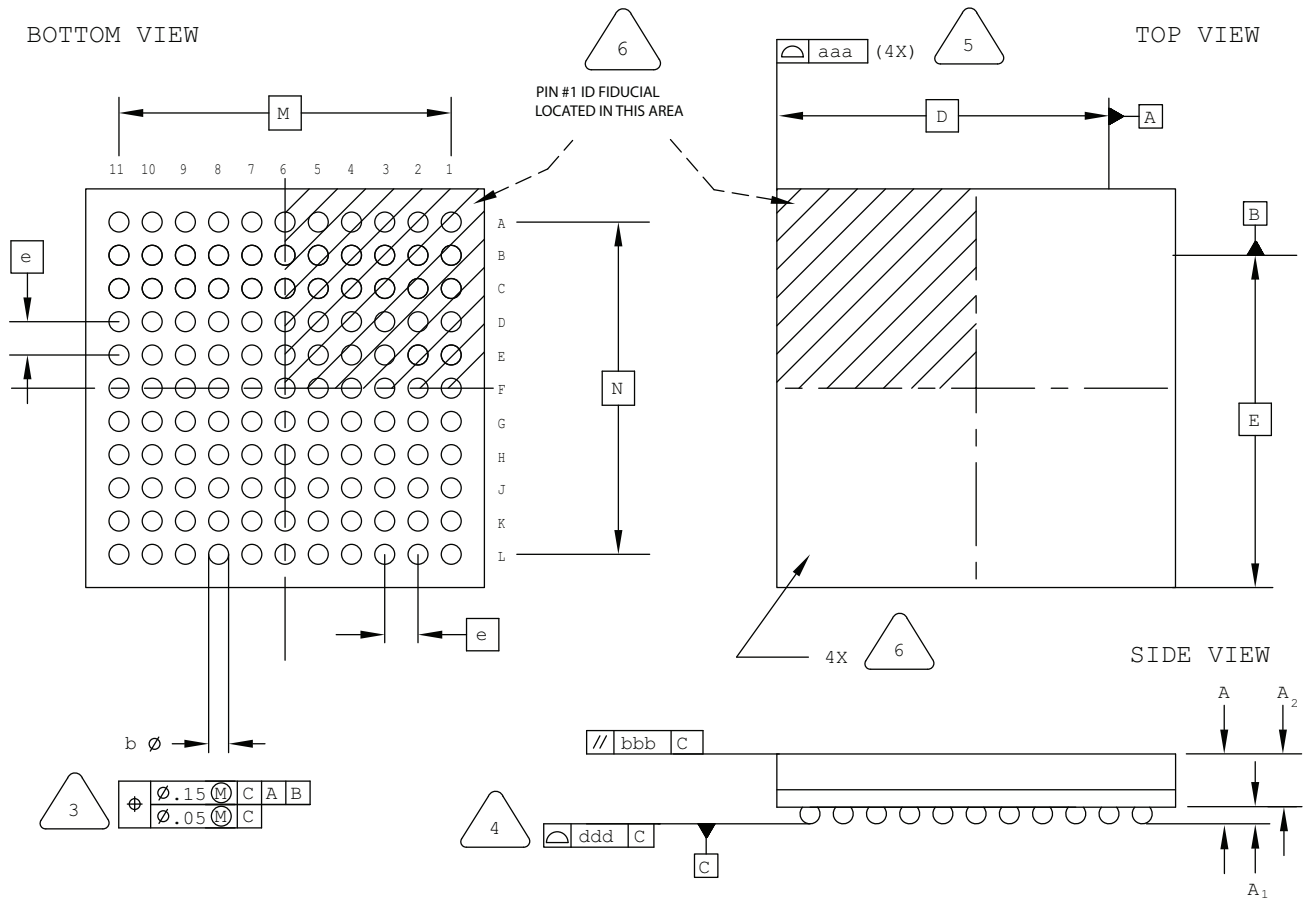
1. DIMENSIONS AND TOLERANCES  
PER ANSI Y14.5M.
2. ALL DIMENSIONS ARE IN MILLIMETERS.

- 3 DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]
- 4 PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 5 BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.
- 6 EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

| SYMBOL | MIN.     | NOM. | MAX. |
|--------|----------|------|------|
| A      | 0.90     | 1.23 | 1.35 |
| A1     | 0.15     | -    | -    |
| A2     | -        | -    | 1.10 |
| D/E    | 8.00 BSC |      |      |
| M/N    | 6.50 BSC |      |      |
| S      | 0.25 BSC |      |      |
| b      | 0.25     | 0.30 | 0.35 |
| e      | 0.50 BSC |      |      |
| aaa    | -        | -    | 0.10 |
| bbb    | -        | -    | 0.10 |
| ddd    | -        | -    | 0.08 |

## 121-Ball csBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

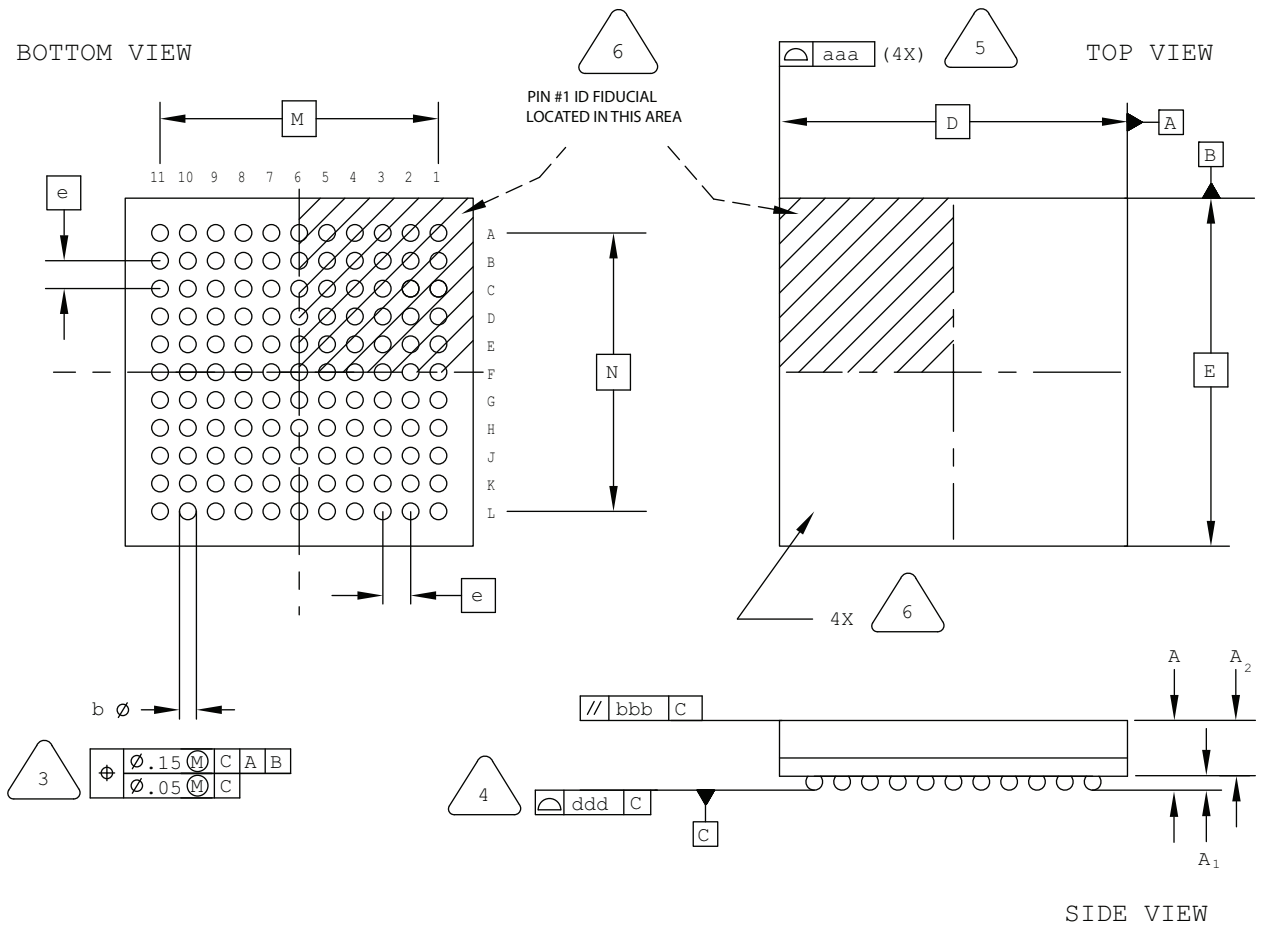
1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
2. ALL DIMENSIONS ARE IN MILLIMETERS.

3. DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]
4. PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
5. BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.
6. EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

| SYMBOL | MIN.     | NOM. | MAX. |
|--------|----------|------|------|
| A      | -        | -    | 1.00 |
| A1     | 0.10     | -    | -    |
| A2     | -        | -    | 0.90 |
| D/E    | 6.00 BSC |      |      |
| M/N    | 5.00 BSC |      |      |
| b      | 0.20     | 0.25 | 0.30 |
| e      | 0.50 BSC |      |      |
| aaa    | -        | -    | 0.10 |
| bbb    | -        | -    | 0.10 |
| ddd    | -        | -    | 0.10 |

## 121-Ball ucBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

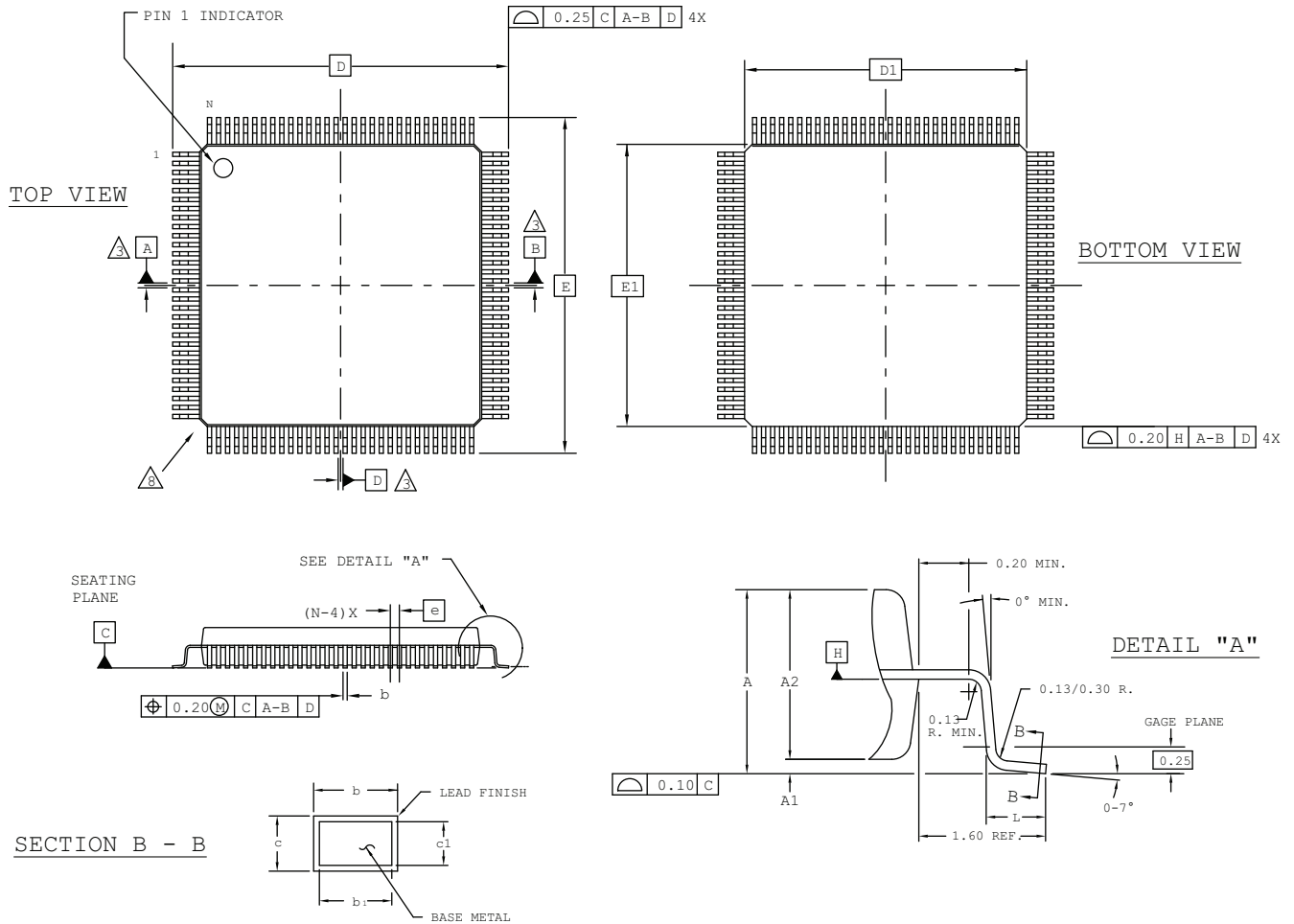
1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
2. ALL DIMENSIONS ARE IN MILLIMETERS.

3. DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]
4. PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
5. BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.
6. EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

| SYMBOL | MIN.     | NOM. | MAX. |
|--------|----------|------|------|
| A      | -        | -    | 1.00 |
| A1     | 0.10     | -    | -    |
| A2     | -        | -    | 0.90 |
| D/E    | 5.00 BSC |      |      |
| M/N    | 4.00 BSC |      |      |
| b      | 0.20     | 0.25 | 0.30 |
| e      | 0.40 BSC |      |      |
| aaa    | -        | -    | 0.10 |
| bbb    | -        | -    | 0.10 |
| ddd    | -        | -    | 0.10 |

## 128-Pin PQFP Package

Dimensions in Millimeters



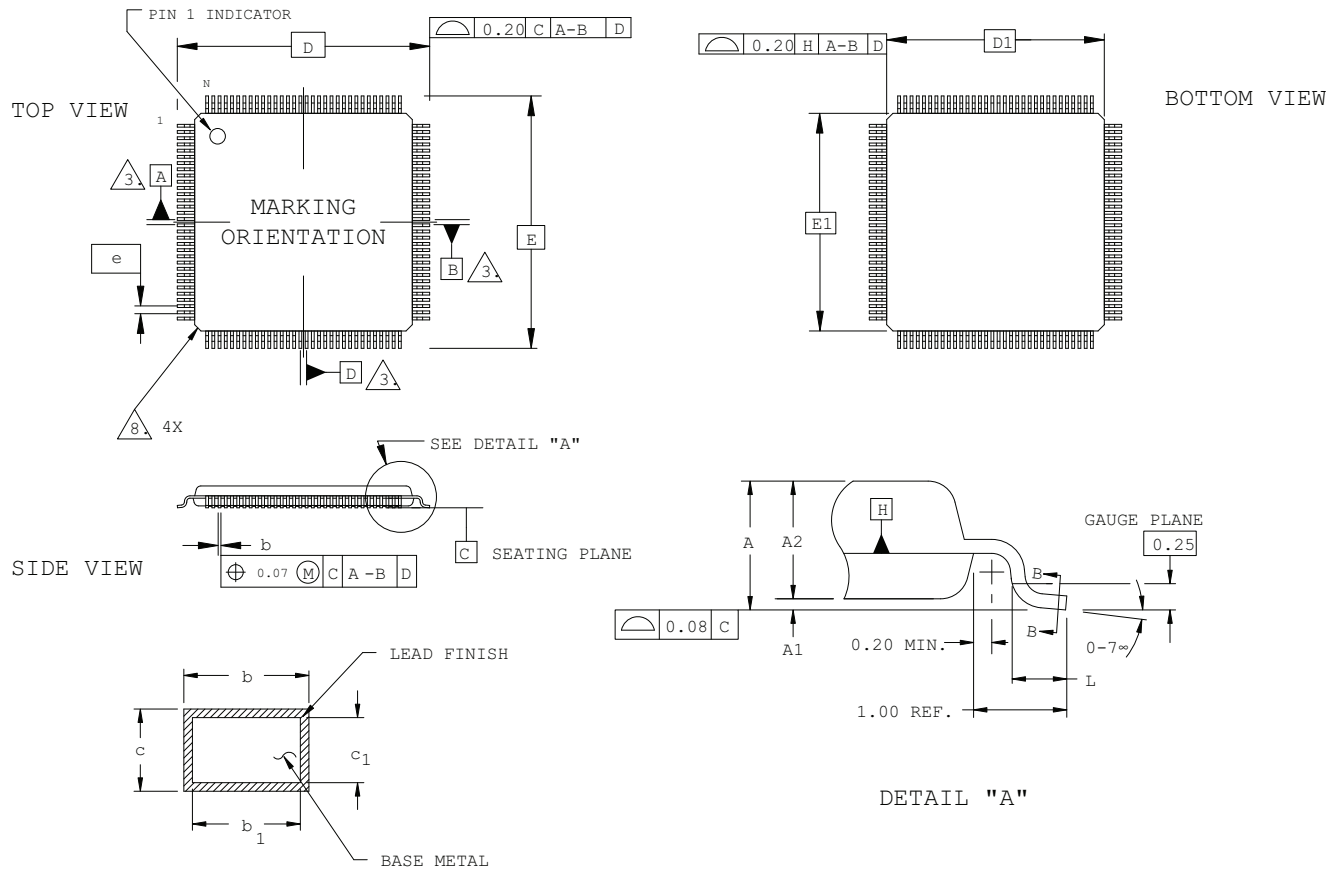
### NOTES:

- 1.0 DIMENSIONING AND TOLERANCING PER ANSI Y14.5 - 1982.
- 2.0 ALL DIMENSIONS ARE IN MILLIMETERS.
- 3.0 DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- 4.0 DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON D1 AND E1 DIMENSIONS.
- 5.0 THE TOP OF PACKAGE MAY BE SMALLER THAN THE BOTTOM OF THE PACKAGE BY 0.15 MM.
- 6.0 SECTION B-B:  
THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP.
- 7.0 A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.
- 8.0 EXACT SHAPE OF EACH CORNER IS OPTIONAL.
- 9.0 EXACT SHAPE OF EXPOSED HEATSINK IS OPTIONAL.

| SYMBOL | MIN.      | NOM. | MAX. |
|--------|-----------|------|------|
| A      | -         | -    | 4.10 |
| A1     | 0.25      | -    | 0.50 |
| A2     | 3.20      | 3.40 | 3.60 |
| D      | 31.20 BSC |      |      |
| D1     | 28.00 BSC |      |      |
| E      | 31.20 BSC |      |      |
| E1     | 28.00 BSC |      |      |
| L      | 0.73      | 0.88 | 1.03 |
| N      | 128       |      |      |
| e      | 0.80 BSC  |      |      |
| b      | 0.29      | -    | 0.45 |
| b1     | 0.29      | 0.35 | 0.41 |
| c      | 0.11      | -    | 0.23 |
| c1     | 0.11      | 0.15 | 0.19 |

## 128-Pin TQFP Package

Dimensions in Millimeters



SECTION B - B

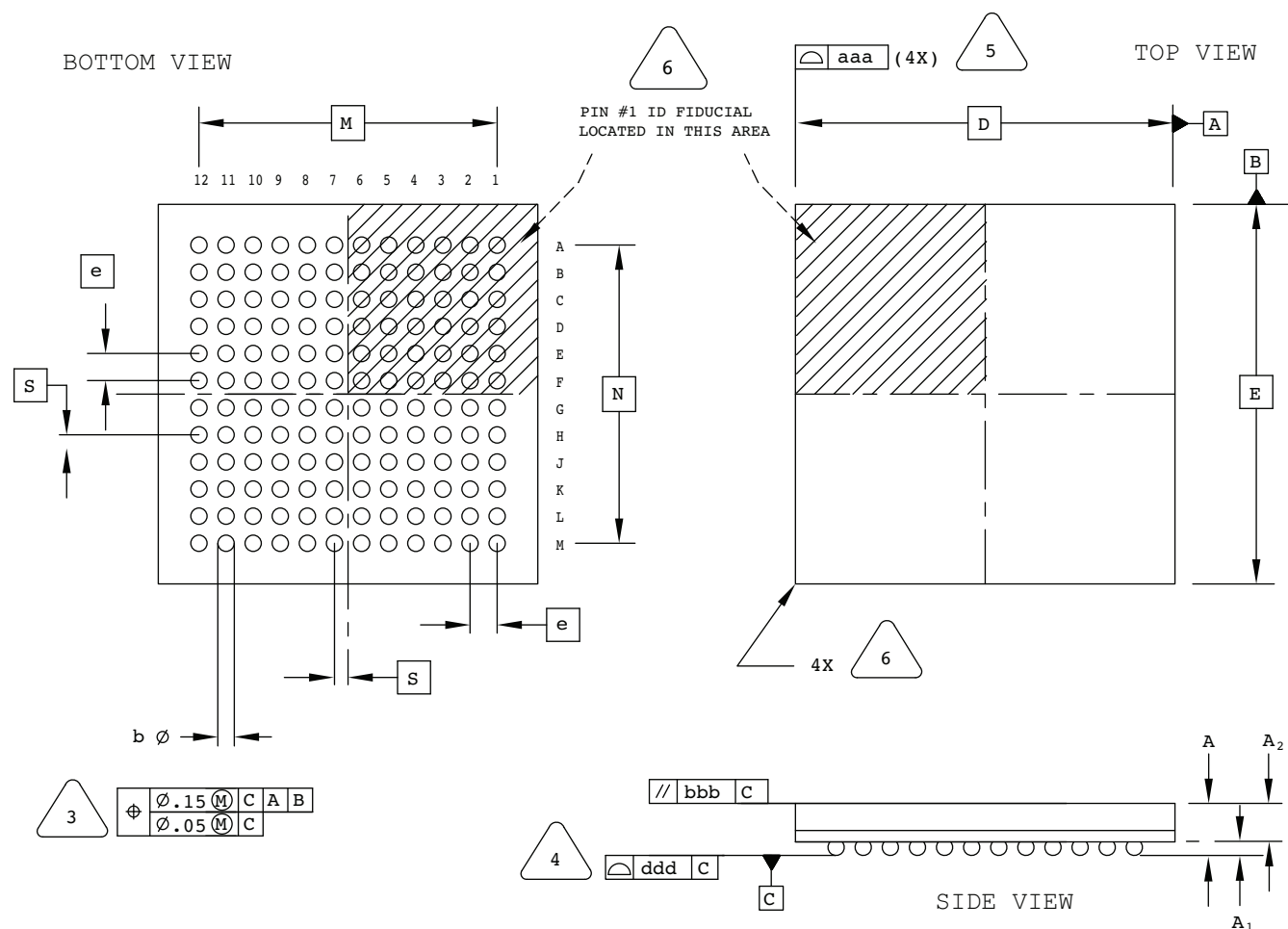
SIDE VIEW

### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5 - 1982.
- ALL DIMENSIONS ARE IN MILLIMETERS.
- DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON D1 AND E1 DIMENSIONS.
- THE TOP OF PACKAGE MAY BE SMALLER THAN THE BOTTOM OF THE PACKAGE BY 0.15 MM.
- SECTION B-B: THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP.
- A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.
- EXACT SHAPE OF EACH CORNER IS OPTIONAL.

| SYMBOL | MIN.      | NOM. | MAX. |
|--------|-----------|------|------|
| A      | -         | -    | 1.60 |
| A1     | 0.05      | -    | 0.15 |
| A2     | 1.35      | 1.40 | 1.45 |
| D      | 16.00 BSC |      |      |
| D1     | 14.00 BSC |      |      |
| E      | 16.00 BSC |      |      |
| E1     | 14.00 BSC |      |      |
| L      | 0.45      | 0.60 | 0.75 |
| N      | 128       |      |      |
| e      | 0.40 BSC  |      |      |
| b      | 0.13      | 0.18 | 0.23 |
| b1     | 0.13      | 0.16 | 0.19 |
| c      | 0.09      | 0.15 | 0.20 |
| c1     | 0.09      | 0.13 | 0.16 |

### Dimensions in Millimeters



1. DIMENSIONS AND TOLERANCES  
PER ANSI Y14.5M.
2. ALL DIMENSIONS ARE IN MILLIMETERS.

 DIMENSION "b" IS MEASURED AT THE  
MAXIMUM SOLDER BALL DIAMETER,  
PARALLEL TO PRIMARY DATUM C


 PRIMARY DATUM C AND SEATING  
 PLANE ARE DEFINED BY THE SPHERICAL  
 CROWNS OF THE SOLDER BALLS.



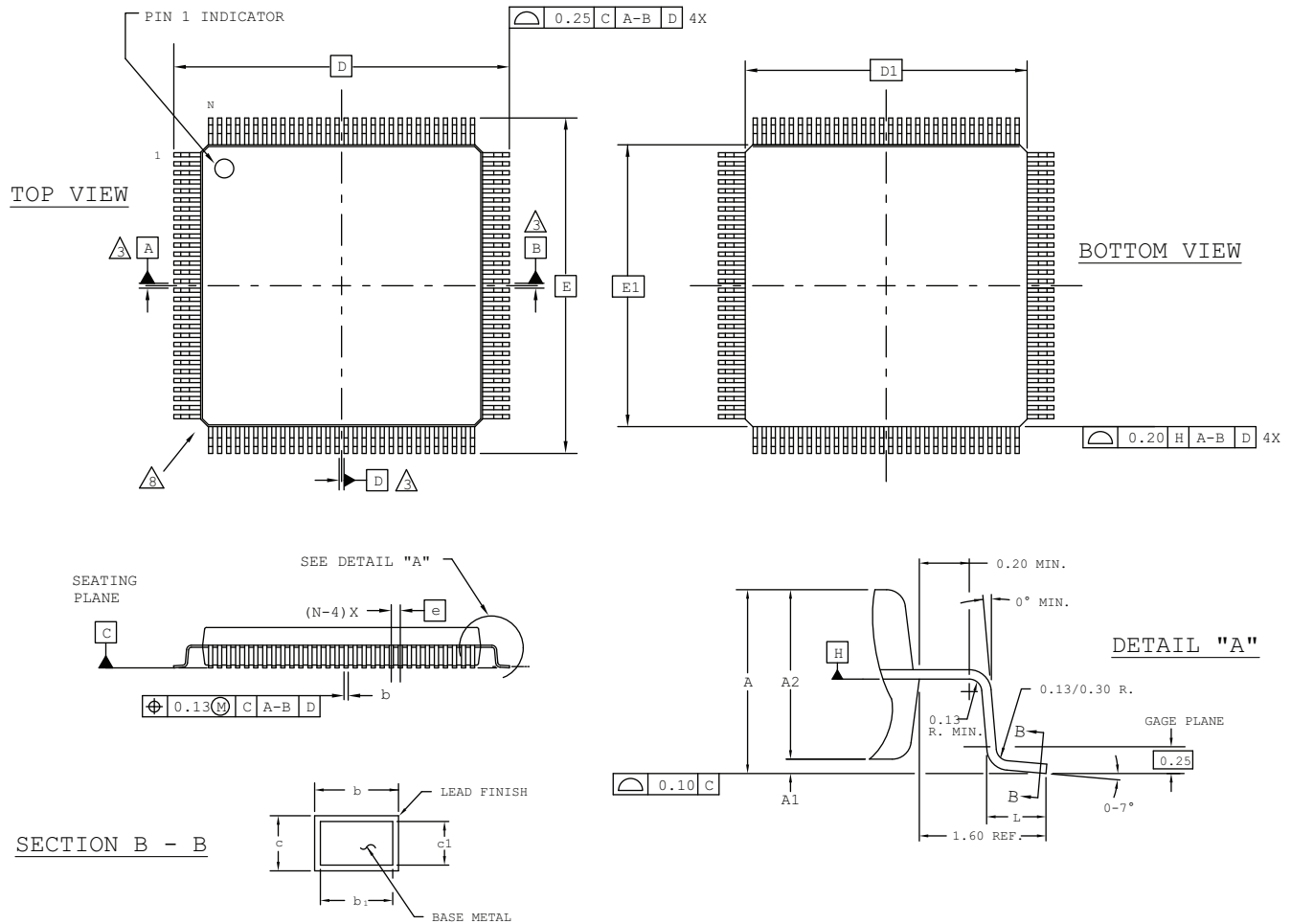
BILATERAL TOLERANCE ZONE IS APPLIED  
TO EACH SIDE OF THE PACKAGE BODY.

6 EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

| SYMBOL | MIN.     | NOM. | MAX. |
|--------|----------|------|------|
| A      | 0.90     | 1.00 | 1.10 |
| A1     | 0.15     | —    | —    |
| A2     | —        | —    | 0.85 |
| D/E    | 7.00 BSC |      |      |
| M/N    | 5.50 BSC |      |      |
| S      | 0.25 BSC |      |      |
| b      | 0.25     | 0.30 | 0.35 |
| e      | 0.50 BSC |      |      |
| aaa    | —        | —    | 0.10 |
| bbb    | —        | —    | 0.10 |
| ddd    | —        | —    | 0.08 |

## 160-Pin PQFP Package

Dimensions in Millimeters



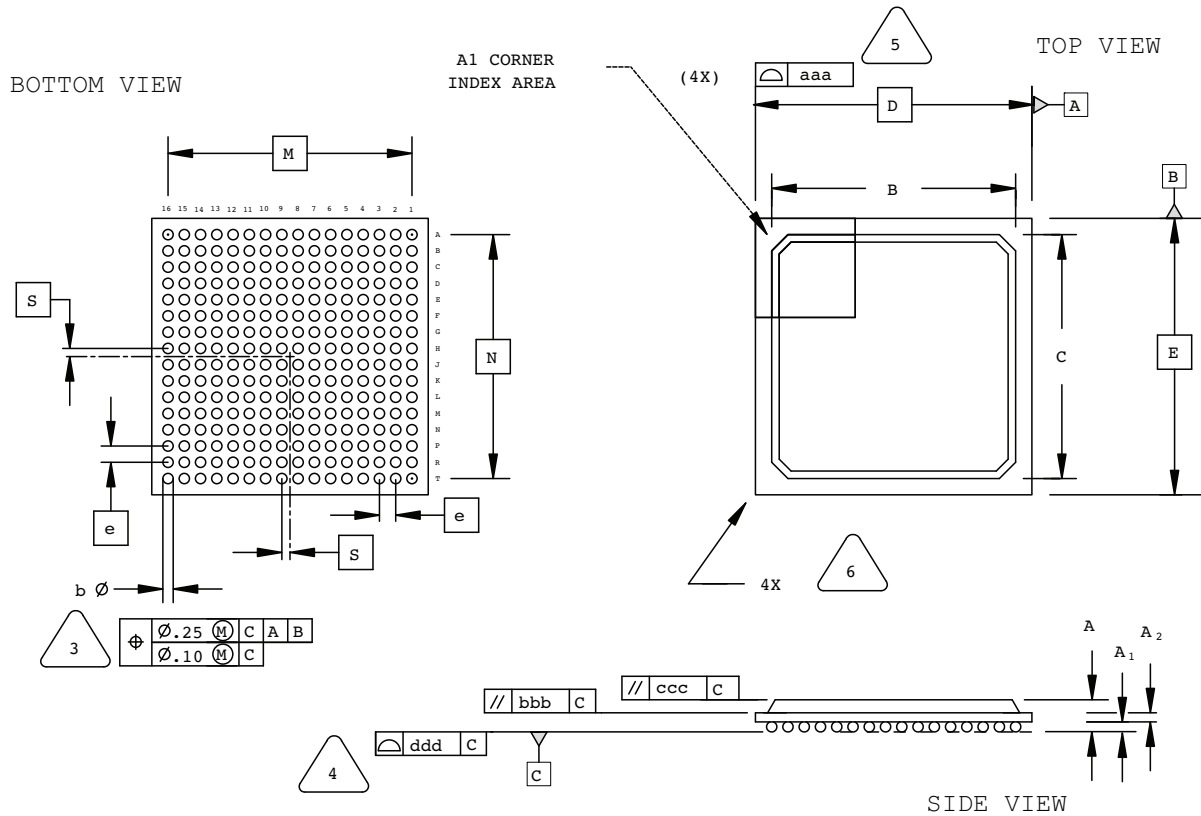
### NOTES:

- 1.0 DIMENSIONING AND TOLERANCING PER ANSI Y14.5 - 1982.
- 2.0 ALL DIMENSIONS ARE IN MILLIMETERS.
3. DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- 4.0 DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON D1 AND E1 DIMENSIONS.
- 5.0 THE TOP OF PACKAGE MAY BE SMALLER THAN THE BOTTOM OF THE PACKAGE BY 0.15 MM.
- 6.0 SECTION B-B:  
THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP.
- 7.0 A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.
8. EXACT SHAPE OF EACH CORNER IS OPTIONAL.
9. EXACT SHAPE OF EXPOSED HEATSINK IS OPTIONAL.

| SYMBOL | MIN.      | NOM. | MAX. |
|--------|-----------|------|------|
| A      | -         | -    | 4.10 |
| A1     | 0.25      | -    | 0.50 |
| A2     | 3.20      | 3.40 | 3.60 |
| D      | 31.20 BSC |      |      |
| D1     | 28.00 BSC |      |      |
| E      | 31.20 BSC |      |      |
| E1     | 28.00 BSC |      |      |
| L      | 0.73      | 0.88 | 1.03 |
| N      | 160       |      |      |
| e      | 0.65 BSC  |      |      |
| b      | 0.22      | -    | 0.40 |
| b1     | 0.22      | 0.30 | 0.36 |
| c      | 0.11      | -    | 0.23 |
| c1     | 0.11      | 0.15 | 0.19 |

## 256-Ball fpBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM **C**



PRIMARY DATUM **C** AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

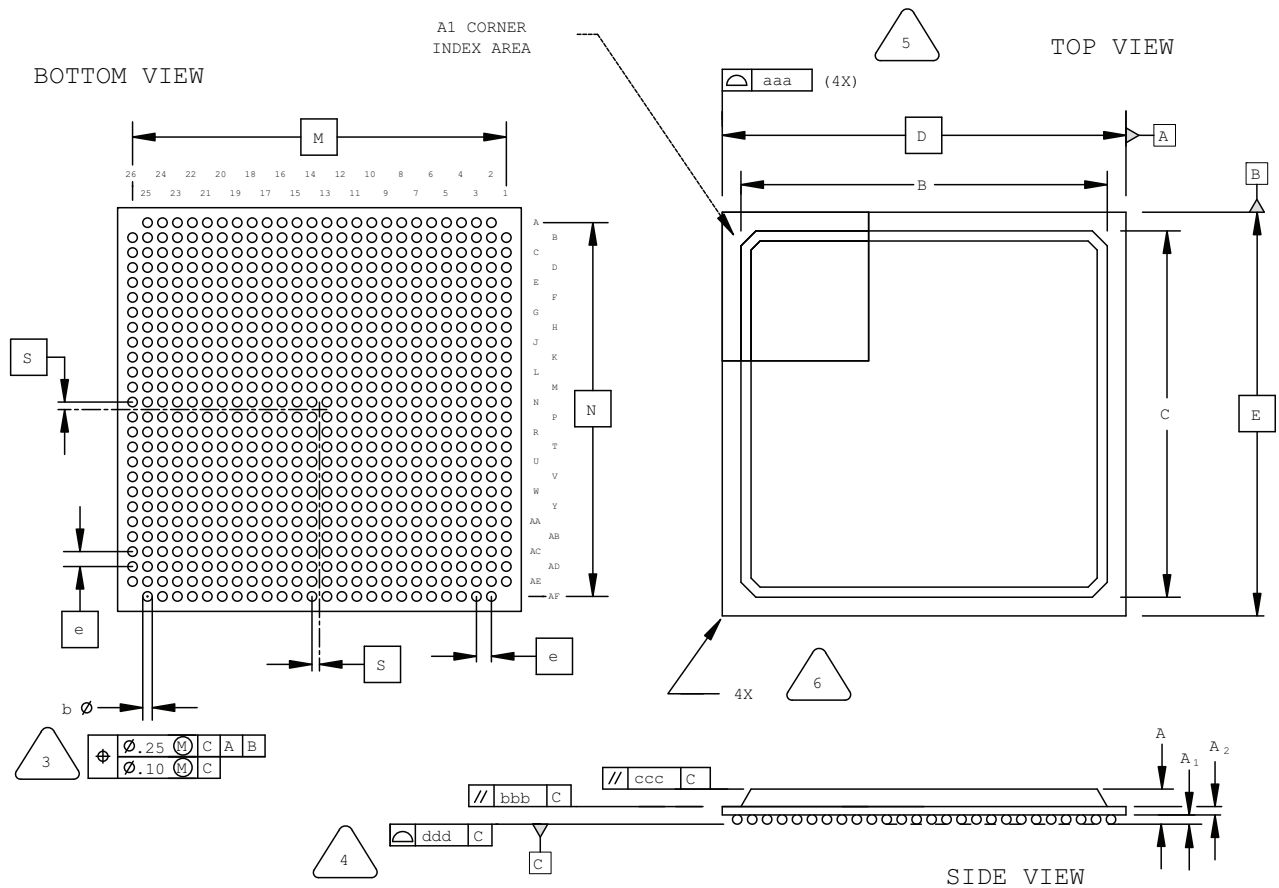


EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

| SYMBOL | MIN.      | NOM.  | MAX.  |
|--------|-----------|-------|-------|
| A      | 1.30      | 1.70  | 2.10  |
| A1     | 0.30      | 0.50  | 0.70  |
| A2     | 0.30      | 0.50  | 0.70  |
| B/C    | 14.80     | 15.30 | 15.80 |
| D/E    | 17.00 BSC |       |       |
| M/N    | 15.00 BSC |       |       |
| S      | 0.50 BSC  |       |       |
| b      | 0.50      | 0.60  | 0.70  |
| e      | 1.00 BSC  |       |       |
| aaa    | -         | -     | 0.20  |
| bbb    | -         | -     | 0.25  |
| ccc    | -         | -     | 0.35  |
| ddd    | -         | -     | 0.20  |

# 672-Ball fpBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.

2. ALL DIMENSIONS ARE IN MILLIMETERS.

3. DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]

4. PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.

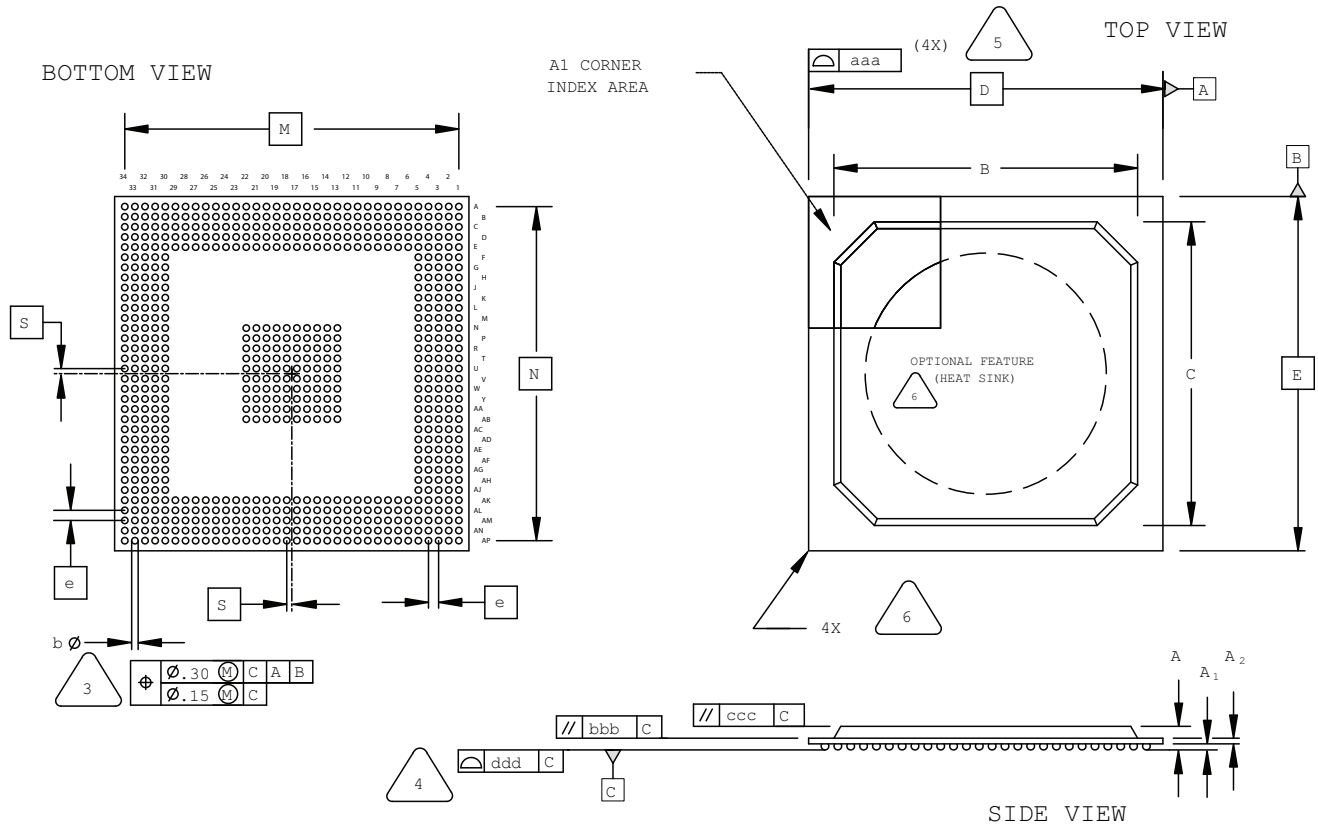
5. BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

6. EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

| SYMBOL | MIN.      | NOM.  | MAX.  |
|--------|-----------|-------|-------|
| A      | 1.70      | 2.15  | 2.60  |
| A1     | 0.30      | 0.50  | 0.70  |
| A2     | 0.30      | 0.50  | 0.70  |
| B/C    | 23.80     | 24.80 | 25.80 |
| D/E    | 27.00 BSC |       |       |
| M/N    | 25.00 BSC |       |       |
| S      | 0.50 BSC  |       |       |
| b      | 0.50      | 0.60  | 0.70  |
| e      | 1.00 BSC  |       |       |
| aaa    | -         | -     | 0.20  |
| bbb    | -         | -     | 0.25  |
| ccc    | -         | -     | 0.35  |
| ddd    | -         | -     | 0.20  |

## 680-Ball fpBGA Package

(with or without Internal Heat Spreader)  
Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]



PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

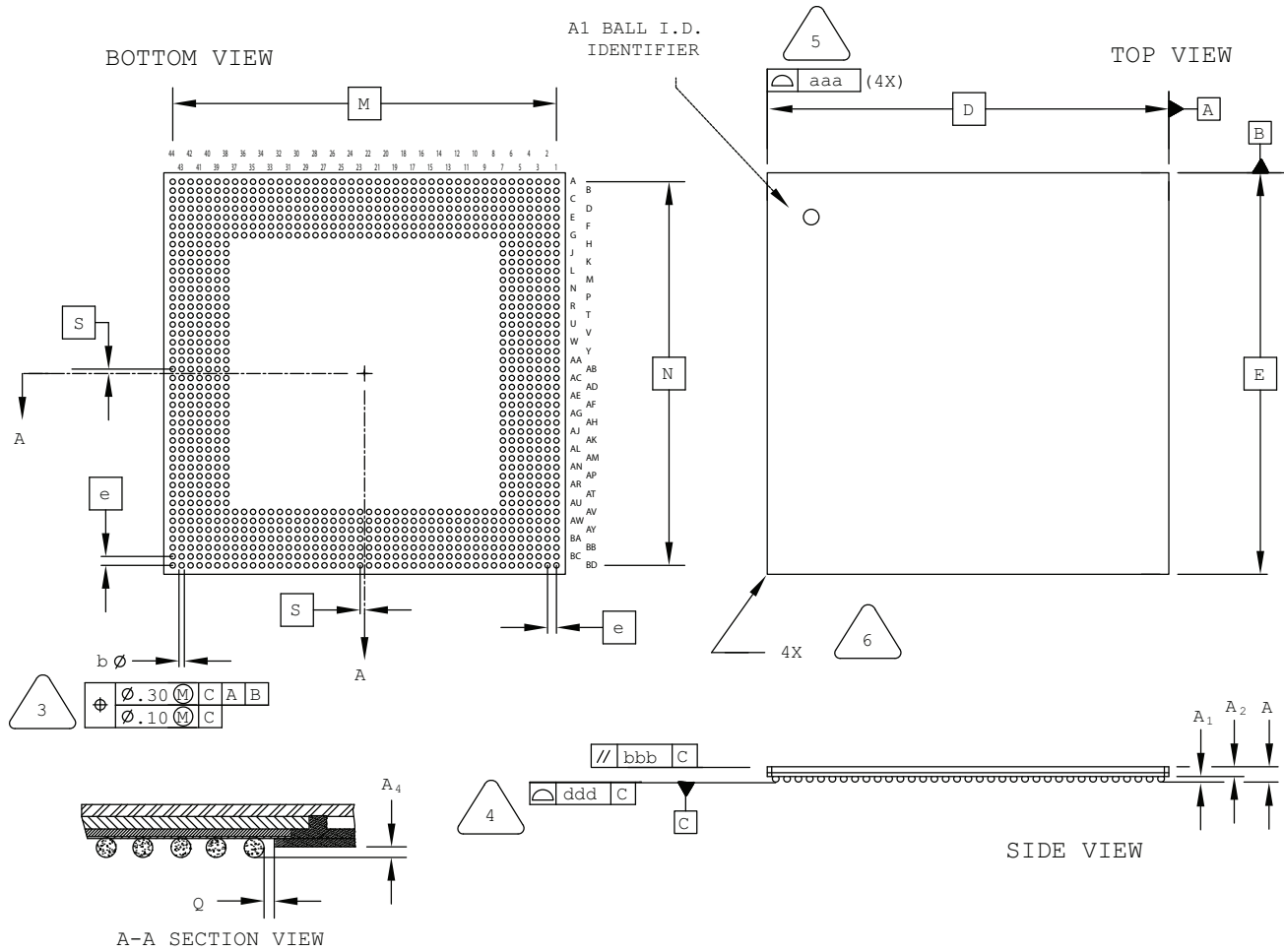


EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

| SYMBOL | MIN.      | NOM.  | MAX.  |
|--------|-----------|-------|-------|
| A      | 1.90      | 2.25  | 2.60  |
| A1     | 0.30      | 0.50  | 0.70  |
| A2     | 0.40      | 0.60  | 0.80  |
| B/C    | 29.80     | 30.30 | 30.80 |
| D/E    | 35.00 BSC |       |       |
| M/N    | 33.00 BSC |       |       |
| S      | 0.50 BSC  |       |       |
| b      | 0.50      | 0.60  | 0.70  |
| e      | 1.00 BSC  |       |       |
| aaa    | -         | -     | 0.20  |
| bbb    | -         | -     | 0.25  |
| ccc    | -         | -     | 0.35  |
| ddd    | -         | -     | 0.20  |

# 1036-Ball ftSBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

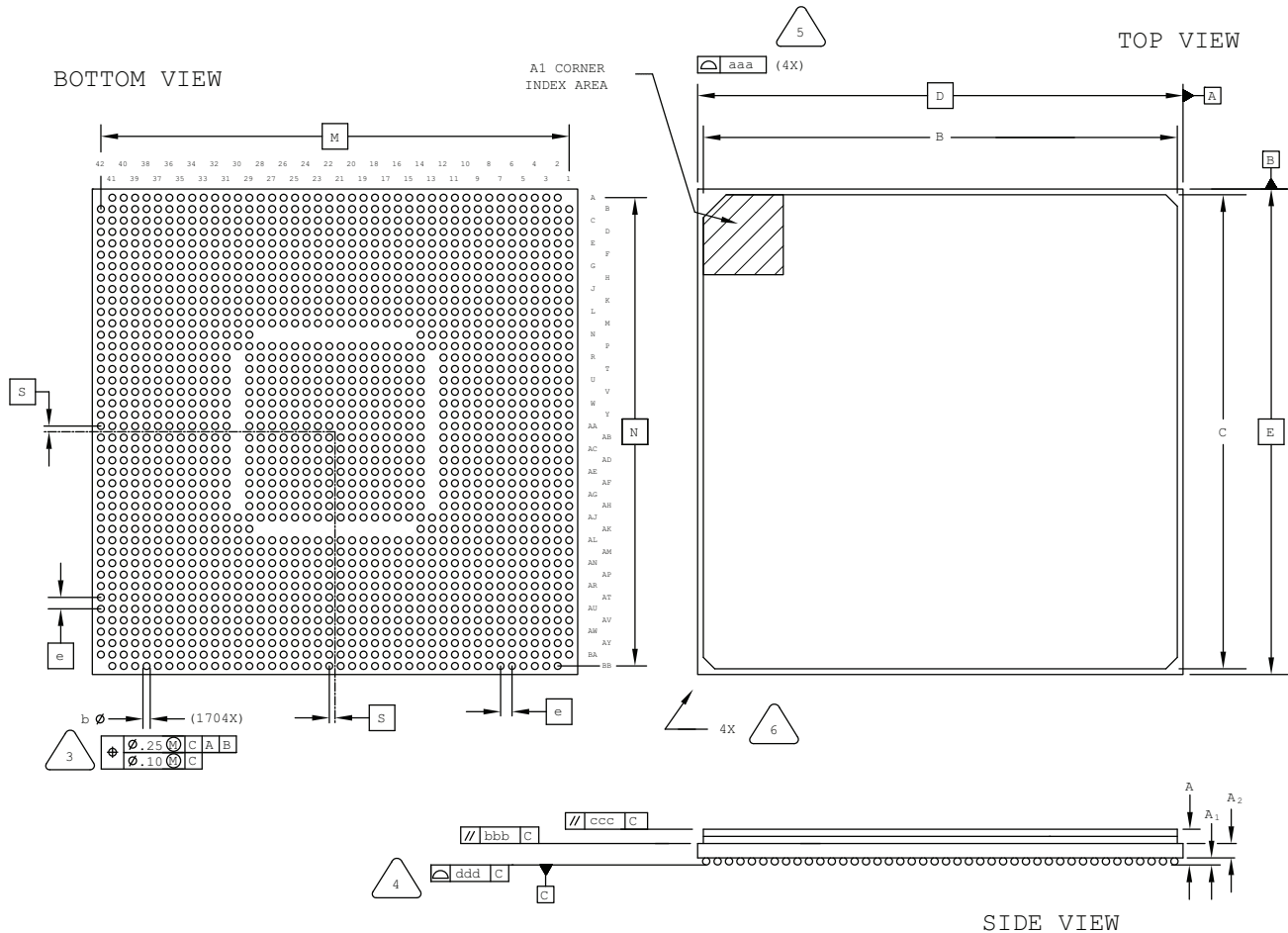
1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
2. ALL DIMENSIONS ARE IN MILLIMETERS.

3. DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]
4. PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
5. BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.
6. EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

| SYMBOL | MIN.      | NOM. | MAX. |
|--------|-----------|------|------|
| A      | -         | -    | 1.80 |
| A1     | 0.40      | 0.55 | 0.70 |
| A2     | 0.90      | 0.98 | 1.10 |
| D/E    | 45.00 BSC |      |      |
| M/N    | 43.00 BSC |      |      |
| S      | 0.50 BSC  |      |      |
| b      | 0.50      | 0.65 | 0.80 |
| e      | 1.00 BSC  |      |      |
| Q      | 0.25      | -    | -    |
| A4     | 0.10      | -    | -    |
| aaa    | -         | -    | 0.20 |
| bbb    | -         | -    | 0.35 |
| ddd    | -         | -    | 0.20 |

# 1704-Ball Organic fcBGA Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]



PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



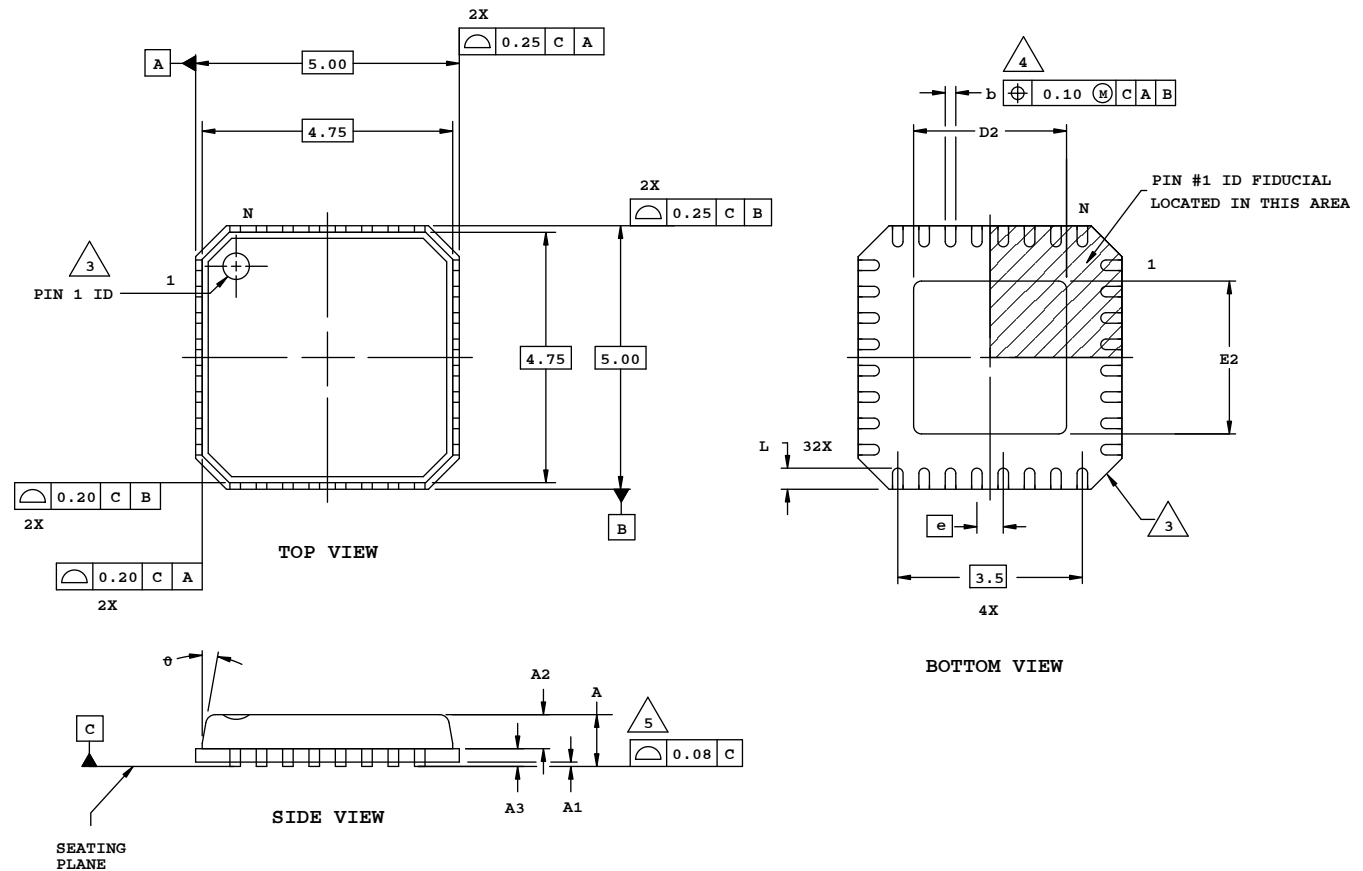
EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

| SYMBOL | MIN.      | NOM.  | MAX.  |
|--------|-----------|-------|-------|
| A      | 2.55      | 2.90  | 3.25  |
| A1     | 0.35      | 0.50  | 0.65  |
| A2     | 1.20 REF  |       |       |
| B/C    | 41.70     | 42.00 | 42.30 |
| D/E    | 42.50 BSC |       |       |
| M/N    | 42.50 BSC |       |       |
| S      | 0.50 BSC  |       |       |
| b      | 0.50      | 0.60  | 0.70  |
| e      | 1.00 BSC  |       |       |
| aaa    | -         | -     | 0.20  |
| bbb    | -         | -     | 0.25  |
| ccc    | -         | -     | 0.35  |
| ddd    | -         | -     | 0.23  |

## Appendix A. Package Archive

### 32-Pin QFN (Punch Singulated) Package

Dimensions in Millimeters



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- ALL DIMENSIONS ARE IN MILLIMETERS.

EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.20 AND 0.25 mm FROM TERMINAL TIP.

APPLIES TO EXPOSED PORTION OF TERMINALS.

| SYMBOL | MIN.     | NOM. | MAX. |
|--------|----------|------|------|
| A      | -        | 0.85 | 1.00 |
| A1     | 0.00     | 0.01 | 0.05 |
| A2     | 0.00     | 0.65 | 1.00 |
| A3     | 0.20 REF |      |      |
| D2     | 1.25     | 2.70 | 3.25 |
| E2     | 1.25     | 2.70 | 3.25 |
| e      | 0.50 BSC |      |      |
| b      | 0.18     | 0.24 | 0.30 |
| L      | 0.30     | 0.40 | 0.50 |
| θ      | -        | -    | 12   |